





# 12-Bit Serializer Deserializer with Multiple Frequency Ranges

#### **Features**

- Low Power Consumption
- Low Power, Proprietary, CTL I/O Serial Interface
- Wide PLL Input Frequency Range
- Wide Parallel Supply Voltage Range: 1.65 to 3.6V
- Low Power Core Operation: V<sub>DDS/A</sub>=2.5 to 3.6V
- Built-in LV-CMOS Voltage Translation Capability with no External Components
- Adjustable Parallel Edge Rate
- Operates as Serializer or Deserializer
- Standby Power-Down Mode Support
- Built-in Differential Termination

#### **Applications**

- 8-Bit LCD Displays for Cell Phones
- 8/10-Bit Cell Phone Camera Interface
- 8-Bit LCD Displays for Printers

#### **Related Application Notes**

- AN-5058 µSerDes™ Family Frequently Asked Questions
- AN-5061 µSerDes<sup>™</sup> Layout Guidelines

### Description

The FIN212AC µSerDes is a low-power serializer / deserializer optimized for use in cell phone displays and camera paths. The device reduces a 12-bit data path to four wires. The device can be configured as a serializer or deserializer through the DIRI pin, minimizing component types in the system. For camera applications, an additional master clock can be passed in the opposite direction of data flow.

The device utilizes Fairchild's proprietary ultra-low power, low-EMI technology. LV-CMOS parallel output buffers have been implemented with slew rate control to adjust for capacitive loading and to minimize EMI. The device also supports an ultra-low power-down mode for conserving power in battery-operated applications

The device is available in a 5x5mm MLP package to attach directly to a flex circuit, or in two choices of BGA, where space constraints are a concern.

### **Ordering Information**

| Order Number | Package                 | Pb-<br>Free | Operating<br>Temperature<br>Range | Package Description   | Packing<br>Method |
|--------------|-------------------------|-------------|-----------------------------------|---|-------------------|
| FIN212ACMLX  | MLP032A                 | Yes         | -30 to 70°C                       | 32-Terminal Molded Leadless Package (MLP), Quad, JEDEC MO-220, 5mm square                                   | Tape &<br>Reel    |
| FIN212ACGFX  | BGA42A                  | Yes         | -30 to 70°C                       | 42-Ball Ultra Small-Scale Ball Grid Array<br>(USS-BGA), JEDEC MO-195, 3.5 x 4.5mm<br>wide, 0.5mm Ball Pitch | Tape &<br>Reel    |
| FIN212ACBFX  | BGA36A<br>(Preliminary) | Yes         | -30 to 70°C                       | 36-Ball Ultra Small Scale Ball Grid Array<br>(USS-BGA), JEDEC MO-xxx 2.5mm square,<br>0.4mm Ball Pitch      | Tape &<br>Reel    |

#### **Pin Definitions**

| Pin                                     | I/O type     | # of<br>Pins | Description of Signals  |
|---|--------------|--------------|---|
| DP[1:12]                                | CMOS-I/O     | 12           | LV-CMOS Parallel I/O. Direction controlled by DIRI pin.   |
| CKREF                                   | CMOS-IN      | 1            | LV-CMOS clock input and PLL reference.  |
| STROBE                                  | CMOS-IN      | 1            | LV-CMOS strobe input for latching data into the serializer.   |
| CKP                                     | CMOS-<br>OUT | 1            | LV-CMOS word clock output.  |
| DSO+(DSI-) <sup>(1)</sup><br>DSO-(DSI+) | DIFF-I/O     | 2            | CTL Differential serial I/O data signals. (2) DS(I)+: Positive signal of DS(I) pair; DS(I)-: Negative signal of DS(I) pair.   |
| CKSI+, CKSI-                            | DIFF-IN      | 2            | CTL Differential deserializer input bit clock. CKSI+: Positive signal of CKSI pair; CKSI-: Negative signal of CKSI pair.  |
| CKSO+,<br>CKSO-                         | DIFF-OUT     | 2            | CTL Differential serializer output bit clock. CKSO+: Positive signal of CKSO pair; CKSO-: Negative signal of CKSO pair.   |
| S0, S1                                  | CMOS-IN      | 1            | DIRI=1: signals are used to define frequency range for the PLL. DIRI=0: Signals are used to define the edge rate of the deserializer parallel I/Os.   |
| PLL0(PWS0)                              | CMOS-IN      | 1            | DIRI=1: PLL0 signal is used to divide or adjust the serial frequency. DIRI=0: PWS0 signal is used to set the width of the CKP output pulse.   |
| PLL1(PWS1)                              | CMOS-IN      | 1            | DIRI=1: PLL1 Signal is used to divide the serial frequency. DIRI=0: PWS1 pin controls the output pulse width.   |
| TEST /<br>(XTRM)                        | CMOS_IN      | 1            | DIRI=1: TEST=0, Normal Operation. DIRI=0: Termination enable functionality for deserializer. XTRM=0 Internal termination. XTRM=1 External termination required. Ground this pin for serializer. |
| CTL_ADJ<br>(GND)                        | CMOS_IN      | 1            | Adjusts CTL drive for serializer. Ground this pin for deserializer.   |
| DIRI                                    | IN           | 1            | LV-CMOS Control Input. Used to control direction of data flow: DIRI= "1" Serializer, DIRI="0" Deserializer  |
| /DIRO                                   | OUT          | 1            | LV-CMOS Output. Inversion of DIRI in normal operation mode.   |
| VDDP                                    | Supply       | 1            | Power supply for parallel I/O and translation circuitry.  |
| VDDS                                    | Supply       | 1            | Power supply for core and serial I/O.   |
| VDDA                                    | Supply       | 1            | Power supply for analog PLL circuitry.  |
| GND                                     | Supply       | 0            | Ground center pad, ground D4, E3 and NCs for 42-ball BGA. Ground B5, C2, C4 for 36-ball BGA.  |

#### Notes:

- 1. () Indicate deserializer functionality when DIRI=0.
- 2. The DS serial port pins are arranged such that when one device is rotated 180 degrees from the other device, the serial connections properly align without the need for any traces or cable signals to cross. Other layout orientations may require that traces or cables cross.
- 3. All unused LV-CMOS input signals should be connected to GND or VDDP. Signals can be connected directly to the rail or through a resistor.
- 4. All unused LV-CMOS output signals should be allowed to float.

#### **Pin Assignments**

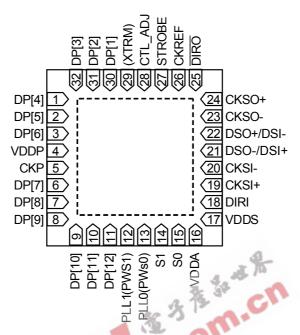


Figure 1. Pin Assignments for 32-Pin MLP (5x5mm, .5mm Pitch, Top View)



Figure 2. Pin Assignments for 42 BGA (3.5x4.5mm, .5mm Pitch, Top View)

|   | 1 2 3 4 5 6 |   | 1    | 2    | 3          | 4       | 5         | 6         |
|---|-------------|---|------|------|------------|---------|-----------|-----------|
| Α | 00000       | Α | DP4  | DP2  | DP1        | (XTRM)  | STROBE    | CKREF     |
| В | 000000      | В | DP6  | DP5  | DP3        | CTL_ADJ | GND       | /DIRO     |
| С | 000000      | С | CKP  | GND  | VDDP       | GND     | CKSO+     | CKSO-     |
| D | 000000      | D | DP7  | DP8  | GND        | VDDS    | DSO-/DSI+ | DS0+/DSI- |
| Е | 000000      | Е | DP9  | DP10 | PLL1(PWS1) | S0      | CKSI+     | CKSI-     |
| F | 000000      | F | DP11 | DP12 | PLL0(PWS0) | S1      | VDDA      | DIRI      |
|   |             |   |      |      |            |         |           |           |

Figure 3. Pin Assignments for 36 BGA (2.5x2.5mm, .4mm Pitch) Preliminary

#### **Control Logic Circuitry**

| Mode | PLL0 | PLL1 | S1 | S0 | DIRI  | Description   |
|------|------|------|----|----|---|---|
| 0    | Х    | Х    | 0  | 0  | Х   | Power-Down Mode   |
| 1    | 1    | 0    | 0  | 1  | 1   | 12-Bit Serializer, Standard Clocking, 20MHz to 40MHz CKREF    |
| 1    | 0    | 0    | 0  | 1  | 1   | 12-Bit Serializer, Over-Clocked PLL, 19MHz to 38.2MHz CKREF   |
| 1    | Х    | Х    | 0  | 1  | 0 12-Bit Deserializer 1 12-Bit Serializer, Standard Clocking, 5MHz to 14MHz CKREF |   |
| 2    | 1    | 0    | 1  | 0  | 1   | 12-Bit Serializer, Standard Clocking, 5MHz to 14MHz CKREF     |
| 2    | 0    | 0    | 1  | 0  | 1   | 12-Bit Serializer, Over-0Clocked PLL, 4.7MHz to 13.3MHz CKREF |
| 2    | Х    | Х    | 1  | 0  | 0   | 12-Bit Deserializer   |
| 3    | 1    | 0    | 1  | 1  | 1   | 12-Bit Serializer, Standard Clocking, 8MHz to 28MHz CKREF     |
| 3    | 0    | 0    | 1  | 1  | 1   | 12-Bit Serializer, Over-Clocked PLL, 9.5MHz to 26.7MHz CKREF  |
| 3    | Х    | Х    | 1  | 1  | 0   | 12-Bit Deserializer   |

**Table 1. Control Logic Circuitry** 

**[DIRI] Direction Logic:** The FIN212 can be configured as a 12-bit serializer or deserializer based on the state of the DIRI signal. When DIRI is 1, the device is a serializer. When DIRI is 0, the device is a deserializer. The /DIRO signal is an inversion of the DIRI signal. The /DIRO signal of the master can be used to drive the DIRI signal of the slave in applications where the interface needs to be turned around.

**[S0, S1] Mode Select:** The mode select signals, S1 and S0, are used for different purposes when the device is a serializer or a deserializer. For the serializer, the pins need to be set to the correct value of the input CKREF Frequency range.

For the deserializer the signals are used to select an edge rate value. The fastest edge rates correspond to the highest frequency mode. This relationship is maintained for all modes.

| NA144  | DIR | RI=0 | Frequency  |
|--------|-----|------|------------|
| Mode # | S1  | S0   | Range      |
| 0      | 0   | 0    | Power-Down |
| 1      | 0   | 1    | FAST       |
| 2      | 1   | 0    | SLOW       |
| 3      | 1   | 1    | MEDIUM     |

Table 2. Deserializer Edge Rates

[PLL0, PLL1] PLL Frequency Select Signals: The PLL1 and PLL0 signals provide additional flexibility in generating the serial clock frequency. The PLLn signals only function when the device is a serializer (DIRI=1). When the device is a slave, these pins are used for pulse width adjustment.

Over-clocking mode is used when the input reference clock has been implemented with significant spread spectrum. Over-clocking allows the serializer to tolerate a large amount of CKREF frequency spread.

No-Divide mode should be used for standard 8-bit pixel interface where the STROBE and CKREF frequencies are identical.

Divide-by-2 and Divide-by-3 modes are useful in microcontroller interfaces where the CKREF frequency is significantly higher than the required STROBE frequency.

|   | DIF  | RI=1 |      | Frequency     |
|---|------|------|------|---------------|
|   | PLL1 | PLL0 | Mul  | ltiplier      |
| L | 0    | 0    | 7.3x | Over-clocking |
|   | 0    | 1    | 7x   | No Divide     |
|   | 1    | 0    | 3.5x | Divide by 2   |
|   | 1    | 1    | 2.3x | Divide by 3   |

**Table 3. Frequency Multipliers** 

**Internal STROBE Filter:** When the PLL starts, the STROBE signal is internally held off until the PLL is locked. This prevents any spurious data from being passed through the device.

[PWS0, PWS1] Pulse Width Adjust Circuitry: The word clock strobe output (CKP) pulse width can be adjusted through the PWS0 and PWS1 signals. The signals can be used to lengthen the width of the LOW pulse or invert the pulse in RGB applications with a 50% duty cycle.

| DIR  | l=0  | Low Time            | Polarity (CKP |
|------|------|---------------------|---------------|
| PWS1 | PWS0 | (Bits)<br>No Divide | Read Edge)    |
| 0    | 0    | 7                   | LH            |
| 0    | 1    | 7                   | HL            |
| 1    | 0    | 13                  | LH            |
| 1    | 1    | 17                  | LH            |

Table 4. Pulse Width Adjust Circuitry at Serial CLK Period

**Power-Down Functionality:** When both S1 and S0 signals are 0, regardless of the state of the DIRI signal, the FIN212AC resets and powers down. The power-down mode shuts down all internal analog circuitry, disables the serial input and output of the device, and resets all internal digital logic. Table 5 indicates the state of the output buffers in Power-Down mode.

| Signal Pins | DIRI=1          | DIRI=0         |
|-------------|-----------------|----------------|
| DP[10:1]    | Inputs Disabled | Outputs HIGH-Z |
| DP[12:11]   | Inputs Disabled | Outputs HIGH-Z |
| CKP         | HIGH            | Outputs HIGH-Z |
| STROBE      | Input Disabled  | Input Disabled |
| CKREF       | Input Disabled  | Input Disabled |
| /DIRO       | 0               | 1              |

Table 5. Output States

When an input is disabled, it does not draw current, regardless of the state or level of the input signal.

All of the LV-CMOS inputs must remain driven during power-down to ensure a low-power state

Turn-Around Functionality: The device passes and inverts the DIRI signal asynchronously to the /DIRO signal. Care must be taken by the system designer to ensure that no contention occurs between the deserializer outputs and the other devices on this port. Optimally the peripheral device driving the serializer should be put into a HIGH-impedance state prior to the DIRI signal being asserted. When a device with dedicated data outputs turns from a deserializer to a serializer, the dedicated outputs remain at the last logical value asserted. This value only changes if the device is once again turned around into a deserializer and the values are overwritten.

**Strobe Pass-Through Mode:** For some applications, it is desirable to pass a word clock across a differential signal pair in the opposite direction of serialization. The FIN212 supports this mode of operation. The following describes how to enable this functionality.

Deserializer Configuration (DIRI=0)

- 1. CKREF LOW
- 2. Master clock connected DES to STROBE

Serializer Configuration (DIRI=1)

1. CKSI passes signal to serializer CKP

[CTL\_ADJ] CTL Drive Adjustment: The drive characteristics of the CTL I/O can be adjusted through the CTL\_ADJ pin. Standard-level CTL drive is provided when the CTL\_ADJ pin is zero. High- level drive is provided when CTL\_ADJ pin is HIGH. High-drive should be used in noisy environments or when driving cables longer than 20cm. When in high-drive mode, CTL drive increases by approximately by 50%.

| CTL_ADJ | Description        |
|---------|--------------------|
| 0       | Standard CTL Drive |
| 1       | High CTL Drive     |

Table 6. CTL\_ADJ Functionality

[(/XTRM]] Test / XTRM Mode Functionality: For the deserializer, the (XTRM) signal can be used to enable or disable the internal termination resistor on the CKS and DS signals of the deserializer. When the internal termination is disabled, an external termination resistor is required for the CTL I/O to operate properly.

| (XTRM) | DIRI=0 (/XTRM)       |
|--------|----------------------|
| 0      | Internal Termination |
| 2      | External Termination |

Table 7. (/XTRM) Functionality

Serializer Configuration (DIRI=1)

- Master CLK transmitted out of SER CKP
- Drive the pixel\_CLK [(/XTRM)] into SER TROBE
   Deserializer Configuration (DIRI=0)
- Pixel\_CLK transmitted out of DES CKP

#### Serializer Operation Mode (DIRI=1)

The serializer configurations are described in the following sections. The basic serialization circuitry works similarly in all modes, but the actual data and clock streams differ if the frequency of CKREF is the same as or greater than the STROBE frequency. When CKREF equals STROBE, the CKREF and STROBE signals are physically connected together and are one signal. When CKREF does not equal STROBE, each signal is distinct and CKREF must be running at a frequency high enough to avoid any loss of data condition. CKREF must never be a lower frequency than STROBE. For proper serialization, the PLL should be stable and locked prior to sending valid data. For the following modes, refer to Table 1.

# MODE 1,2,3; PLL1=0, PLL0=1; CKREF Equals STROBE

This mode is typically used when sending pixel data at a constant rate. Data is captured on the rising edge of the STROBE signal and serialized. The serial CLK frequency is exactly seven times the clock frequency. For example, a CKREF frequency of 10MHz results in a serial CLK frequency of 70MHz and a data transfer rate of 140Mbps. The serialized data stream is synchronized and sent source synchronously with a bit clock.

# MODE 1,2,3; PLL1=0, PLL0=1; CKREF Does Not Equal STROBE

For microcontroller interfaces, a reference clock at the same frequency as the strobe is typically not available. Data transfers are typically not synchronous. To accommodate this type of transfer, a reference clock of a higher frequency than the fastest strobe frequency must

be provided to the CKREF signal. The CKREF clock signal must be continuously running for as long as data is being transferred. The actual serial transfer rate is dependent on the CKREF and the parallel transfer rate depends on the STROBE frequency. A data value of zero is sent when no valid data is present in the serial bit stream. The operation of the serializer otherwise remains the same. The exact frequency that the reference clock needs to run is dependent upon the stability of the CKREF and STROBE signal. If the source of the CKREF signal implements spread spectrum technology, the minimum frequency of this spread spectrum clock should be used in calculating the ratio of STROBE frequency to the CKREF frequency. Similarly if the STROBE signal has significant cycle-to-cycle variation, the maximum cycle-to-cycle time needs to be factored into the selection of the CKREF frequency. A STROBE frequency of 7MHz and a CKREF of 11MHz results in serial CLK frequency seven times the CKREF (77MHz) and a data transfer rate of 154Mbps.

# MODES (1,2,3); PLL1=1,PLL0=0 (Divide-by-2) or PLL1=1,PLL0=1 (Divide-by-3)

For some microcontroller applications, the available reference frequency is significantly faster than the STROBE frequency required for the application. To more closely match the serial frequency with the strobe, the reference frequency can be divided by two or three. The serializer works identically to when CKREF is not equal to STROBE. Refer to the Deserializer Operation Mode section below for details.

#### **Deserializer Operation Mode**

The operation of the deserializer is dependent upon the data received on the DSI data signal pair and the CKSI clock signal pair. The following sections describe the operation of the deserializer under two distinct serializer source conditions. References to the CKREF and STROBE signals refer to the signals associated with the serializer device used to generate the serial data and clock signals. When operating in this mode, the internal serializer circuitry is disabled, including the parallel data input buffers. If there is a CKREF signal provided, the CKSO serial clock continues to transmit bit clocks.

**DIRI = 0; Serializer Source: CKREF Equals STROBE**When the DIRI signal is asserted LOW, the device is configured as a deserializer. Data is captured on the

serial port and deserialized through a bit clock sent with the data. The falling edge of CKP occurs coincident with the parallel data transition.

#### DIRI=0; Serializer Source: CKREF Does Not Equal STROBE

The logical operation of the deserializer remains the same whether CKREF is equal in frequency to STROBE or at a higher frequency than STROBE. The duty cycle of CKP varies based on the ratio of the frequency of the CKREF signal to the STROBE signal. The average frequency of the CKP signal is equal to the STROBE frequency. The falling edge of CKP is coincident with data transition. The LOW time of the CKP signal is set by the state of the PWS1 and PWS0 signals.

#### **Pulse Width Calculations**

Pulse Width Low Tpwl = (divOut\*Pwdth)/(CKREF\*14)

To meet minimum pulse width specification, divOut\*Pwdth≥Tpwl\*(T<sub>CKREF</sub>\*14).

Bit times based on PWS0, PWS1 (Pwdth = 7, 13, 17), divide by divOut = 0.954, 1, 2, 3.

Example: Tpwl=60ns CKREF=26MHz

CKP Pulsewidth = (2\*13)/(26MHz\*14)

if DivOut=2, Pwdth=13 bitTimes=26. Tpwl=71.4ns

| Serialize | er Setup | Deserializ | zer Setup | PLL    | Pwidth | CKP-PWL   | CKREF   | requency |
|-----------|----------|------------|-----------|--------|--------|-----------|---------|----------|
| PLL1      | PLL0     | PWS1       | PWS0      | DivOut |        | Bit Times | 19.2MHz | 26Mhz    |
| 0         | 0        | 0          | 0         | 0.954  | 7      | 6.7       | 24.8    | 18.3     |
| 0         | 0        | 0          | 1         | 0.954  | 7, 3   | 6.7       | 24.8    | 18.3     |
| 0         | 0        | 1          | 0         | 0.954  | 13     | 12.4      | 46.1    | 34.1     |
| 0         | 0        | 1          | 1         | 0.954  | 17     | 16.2      | 60.3    | 44.6     |
| 0         | 1        | 0          | 0         | 1      | 7      | 7         | 26.0    | 19.2     |
| 0         | 1        | 0          | 1         | 1      | 7      | 7         | 26.0    | 19.2     |
| 0         | 1        | 1          | 0         | 1      | 13     | 13        | 48.4    | 35.7     |
| 0         | 1        | 1          | 1         | 1      | 17     | 17        | 63.2    | 46.7     |
| 1         | 0        | 0          | 0         | 2      | 7      | 14        | 52.1    | 38.5     |
| 1         | 0        | 0          | 1         | 2      | 7      | 14        | 52.1    | 38.5     |
| 1         | 0        | 1          | 0         | 2      | 13     | 26        | 96.7    | 71.4     |
| 1         | 0        | 1          | 1         | 2      | 17     | 34        | 126.5   | 93.4     |
| 1         | 1        | 0          | 0         | 3      | 7      | 21        | 78.1    | 57.7     |
| 1         | 1        | 0          | 1         | 3      | 7      | 21        | 78.1    | 57.7     |
| 1         | 1        | 1          | 0         | 3      | 13     | 39        | 145.1   | 107.1    |
| 1         | 1        | 1          | 1         | 3      | 17     | 51        | 189.7   | 140.1    |

Table 8. CKP Pulse Widths (in nanoseconds) for Standard Cell Phone Operating Frequencies (5)

#### Note:

5. CKP Pwidth assumes minimal slew rate at the 50% transition point.

#### **Application Diagrams**

The following application diagrams illustrate the most typical applications for the FIN212 device. Specific configurations of the control pins may vary based on the needs of a given system. The following recommendations are valid for all of the applications shown.

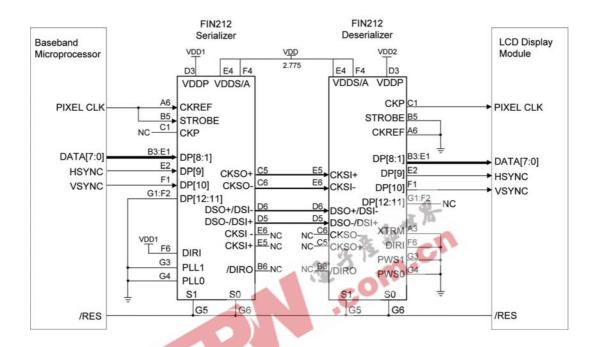


Figure 4. 8-Bit RGB Application (Example Shows BGA 42-Pin Package)

#### Serializer Configuration:

- PLL Frequency Mode: MODE 3 (S1=S0=1) 10-30MHz Frequency Range
- PLL Divide Mode: Over-Clocked Mode (PLL1=PLL0=0); 7.3 Serial Frequency Multiplier

#### **Deserializer Configuration:**

- Edge Rate Mode: Medium MODE 3 (S1=S0=1)
- Pulse Width Mode: Standard Non-Inverting, (PWS1=PWS0=0) Pulse Width; 3.5 x Serial CLK Period
- Pixel CLK is used to STROBE Display
- Pin number for BGA packages

#### **Application Diagrams** (Continued)

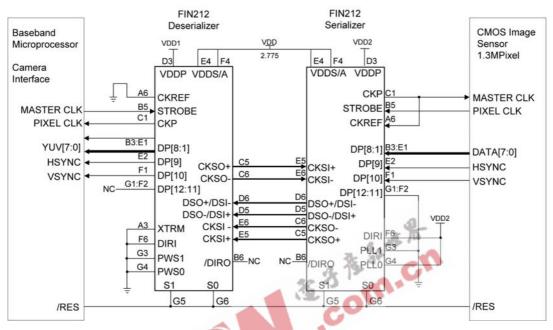


Figure 5. 8-Bit YUV 1.3MPixel CMOS Imager (Example Shows BGA 42-Pin Package)

#### Serializer Configuration:

- PLL Frequency Mode: MODE 3 (S1=S0=1) 10-30MHz Frequency Range
- PLL Divide Mode: Standard Not Over-Clocked (PLL1=0, PLL0=1) Multiplier 7x
- Master Clock Bypass Mode: (clock passes from CKSI to CKP)

#### **Deserializer Configuration:**

- Edge Rate Mode: Fast MODE 1 (S1=0, S0=1)
- Pulse Width Mode: Standard Non-Inverting, (PWS1=PWS0=0) Pulse Width; 3.5 x Serial CLK Period
- Master Clock Bypass Mode: Clock passes from STROBE to CKSO

#### **Application Diagrams** (Continued)

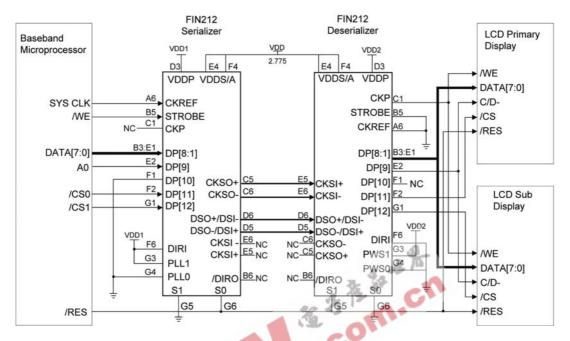


Figure 6. Dual Display with 8-Bit WRITE-Only Microcontroller Interface (Example Shows BGA 42-Pin Package)

#### Serializer Configuration:

- PLL Frequency Mode: MODE 1 (S1=0, S0=1) CKREF=26MHz
- STROBE Frequency = 10 MHz
- PLL Divide Mode: Divide-by 2 (PLL1=1, PLL0=0) Multiplier x 3.5

#### **Deservation:**

- Edge Rate Mode: SLOW MODE 1 (S1=1, S0=0)
- Pulse Width Mode: 13-Bit Time Mode (PWS1=PWS0=0) (~71.4ns)

#### **Additional Application Information**

**Flex Cabling:** The serial I/O information is transmitted at a high serial rate. Care must be taken implementing this serial I/O flex cable. The following best practices should be used when developing the flex cabling or Flex PCB.

- Keep all four differential Serial Wires the same length.
- Do not allow noisy signals over or near differential serial wires.
   Example: No LVCMOS traces over differential serial wires.
- Use only one ground plane or wire over the differential serial wires. Do not run ground over top and bottom.
- Design goal of 100-ohms differential characteristic impedance.
- Do not place test points on differential serial wires.
- Use differential serial wires a minimum of 2cm away from the antenna.
- For additional applications notes or flex guidelines see your sales rep or contact Fairchild directly.

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol           | Parameter                                  | Min.       | Max.                 | Unit |
|------------------|--|------------|----------------------|------|
| $V_{DD}$         | Supply Voltage                             | -0.5V      | +4.6                 | V    |
|                  | All Input/Output Voltage                   | -0.5       | V <sub>DD</sub> +0.5 | V    |
|                  | CTL Output Short-Circuit Duration          | Continuous |                      |      |
| T <sub>STG</sub> | Storage Temperature Range                  | -65        | +150                 | °C   |
| TJ               | Maximum Junction Temperature               | +150       |                      | °C   |
| T <sub>L</sub>   | Lead Temperature (Soldering, four seconds) | +260       |                      | °C   |
|                  | Human Body Model, 1.5KΩ, 100pF             |            | 8                    | kV   |
| ESD              | Human Body Model, 1.5KΩ, Serial I/O Pins   | 4          | 14                   | kV   |
|                  | Machine Model, 0Ω, 200pF                   | 4 1 1      | 400                  | V    |
| ecomme           | ended Operating Conditions                 | om.cr      |                      |      |

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol             | Parameter             | Min. | Max. | Unit  |
|--------------------|-----------------------|------|------|-------|
| $V_{DDA}, V_{DDS}$ | Supply Voltage        | 2.5  | 3.6  | V     |
| $V_{DDP}$          | Supply Voltage        | 1.65 | 3.6  | V     |
| T <sub>A</sub>     | Operating Temperature | -30  | +70  | °C    |
| $V_{DDA-PP}$       | Supply Noise Voltage  | 100  |      | mVp-p |

#### **DC Electrical Characteristics**

Values are provided for over-supply voltage and operating temperature ranges, unless otherwise specified.

| Symbol                         | Parameter                                     | Test C                             | Conditions                 | Min.                  | Typ. <sup>(6)</sup> | Max.                          | Unit |
|--------------------------------|---|------------------------------------|----------------------------|-----------------------|---------------------|-------------------------------|------|
| LVCMOS                         | 1/0   |                                    |                            |                       |                     |                               |      |
| V <sub>IH</sub>                | Input High Voltage                            |                                    |                            | 0.65xV <sub>DDP</sub> |                     | $V_{DDP}$                     |      |
| $V_{IL}$                       | Input Low Voltage                             |                                    |                            | GND                   |                     | $0.35 \text{xV}_{\text{DDP}}$ | V    |
|                                |   | I <sub>OH</sub> =-2.0m/            | A, S1=0,S0=1               |                       |                     |                               |      |
| $V_{OH}$                       | Output High Voltage                           | I <sub>OH</sub> =-0.4mA            | A, S1=1,S0=0               | $0.75xV_{DDP}$        |                     | $V_{DDP}$                     | V    |
|                                |   | I <sub>OH</sub> =-1.0m/            | A, S1=1,S0=1               |                       |                     |                               |      |
|                                |   | I <sub>OL</sub> =2.0mA,            | S1=0,S0=1                  |                       |                     |                               |      |
| $V_{OL}$                       | Output Low Voltage                            | I <sub>OL</sub> =0.4mA,            | S1=1,S0=0                  | 0                     |                     | $0.25 \text{xV}_{\text{DDP}}$ | V    |
|                                |   | I <sub>OL</sub> =1.0mA,            | S1=1,S0=1                  |                       |                     |                               |      |
| I <sub>IN</sub>                | Input Current                                 | V <sub>IN</sub> = 0V to            | 3.6V                       | -5.0                  |                     | 5.0                           | μΑ   |
| DIFFERE                        | NTIAL I/O                                     |                                    |                            | 4                     | esta                |                               |      |
|                                | Output HIGH Source                            | V <sub>OS</sub> =1.0V              | CTL_ADJ=0                  | 4.45.10               | -2.0                |                               | mA   |
| I <sub>ODH</sub>               | Current                                       | V <sub>OS</sub> -1.0V              | CTL_ADJ=1                  | 表等                    | -3.4                |                               | ША   |
| 1                              | Output LOW Sink Current                       | V <sub>OS</sub> =1.0V              | CTL_ADJ=0                  | 1                     | 1.2                 |                               | mA   |
| I <sub>ODL</sub>               | Output LOW Slink Current                      | V <sub>OS</sub> -1.0V              | CTL_ADJ=1                  | Olive                 | 2.0                 |                               | шд   |
| V <sub>GO</sub> <sup>(7)</sup> | Input Voltage Ground<br>Offset                |                                    | 1 .0                       |                       | 0                   |                               | V    |
| P                              | CKS Internal Receiver<br>Termination Resistor | V <sub>ID</sub> = 50mV<br>DIRI = 0 | , V <sub>IC</sub> = 925mV, | 80                    | 100                 | 120                           | Ω    |
| R <sub>TRM</sub>               | DS Internal Receiver<br>Termination Resistor  | V <sub>ID</sub> =50mV,<br>DIRI = 0 | V <sub>IC</sub> = 925mV,   | 80                    | 100                 | 120                           | Ω    |

- Typical values are given for  $V_{DD}$ =2.775V and  $T_A$ =25 °C. Positive current values refer to the current flowing into the device and negative values refer to the current flowing out of pins. Voltages are referenced to GROUND unless otherwise specified (except  $\Delta V_{OD}$  and  $V_{OD}$ ).

  7.  $V_{GO}$  is the difference in device ground levels between the CTL driver and the CTL receiver.

## **Power Supply Currents**

| Symbol               | Parameter   | Test Condi  | tions |       | Min. | Тур. | Max. | Unit |
|----------------------|---|---|-------|-------|------|------|------|------|
| I <sub>DD_PD</sub>   | V <sub>DD</sub> Power-Down Supply<br>Current<br>I <sub>DD_PD</sub> = I <sub>DDA</sub> + I <sub>DDS</sub> + I <sub>DDP</sub> | S1 = S0 = 0, All Inputs at                              | /DD   |       | 0.1  |      | μA   |      |
|                      |   |   | S1=L  | 20MHz |      | 13.0 |      | mA   |
|                      |   |   | S0=H  | 40MHz |      | 19.0 |      | mA   |
| l                    | Dynamic Serializer Power Supply Current   | $f_{\text{CKREF}} = f_{\text{STRB}},$<br>PLL1=0,PLL0=1; | S1=H  | 5MHz  |      | 9.5  |      | mA   |
| I <sub>DD_SER1</sub> | $I_{DD\_SER1} = I_{DDA} + I_{DDS} + I_{DDP}$  | CTL ADJ=0; $C_L = 0pF$                                  | S0=L  | 14MHz |      | 17.0 |      | mA   |
|                      | 55_62.11. 55.1 556 55.  |   | S1=H  | 8MHz  |      | 11.0 |      | mA   |
|                      |   |   | S0=H  | 28MHz |      | 20.0 |      | mA   |
|                      |   |   | S1=L  | 20MHz |      | 10.0 |      | mA   |
|                      |   |   | S0=H  | 40MHz |      | 14.0 |      | mA   |
| ١.                   | Dynamic Deserializer Power  | $f_{\text{CKREF}} = f_{\text{STRB}}$                    | S1=H  | 5MHz  |      | 8.0  |      | mA   |
| I <sub>DD_DES1</sub> | Supply Current I <sub>DD DES1</sub> = I <sub>DDA</sub> +I <sub>DDS</sub> +I <sub>DDP</sub>                                  | PLL1=0,PLL0=1;<br>CTL_ADJ=0; C <sub>L</sub> = 0pF       | S0=L  | 14MHz |      | 9.0  |      | mA   |
|                      | BB_BEOT BBA BBO BBT   | 30 %  | S1=H  | 8MHz  |      | 9.0  |      | mA   |
|                      |   | 132   | S0=H  | 28MHz |      | 12.0 |      | mA   |
|                      |   |   |       |       |      |      |      |      |

#### **AC Electrical Characteristics**

Values are provided for over-supply voltage and operating temperature ranges, unless otherwise specified.

| Symbol              | Parameter  | Test                                     | Conditions     | Min.                             | Тур. | Max.                              | Unit |
|---------------------|--|--|----------------|----------------------------------|------|-----------------------------------|------|
| Serializer          | Input Operating Condition                                    | s  |                |                                  |      |                                   |      |
|                     |  |  | S1=0, S0=1     | 18                               |      | 40                                |      |
| $f_{CKREF}$         | CKREF Clock Frequency (5MHz - >40MHz)                        | f <sub>CKREF</sub> = f <sub>STRB</sub>   | S1=1, S0=0     | 5                                |      | 14                                | MHz  |
|                     | ,  | OTAL                                     | S1=1, S0=1     | 10                               |      | 28                                |      |
|                     |  |  | PLL1=0, PLL0=0 |                                  |      | 100                               |      |
| £                   | Strobe Frequency<br>Relative to CKREF                        | f <sub>ckref</sub> ≠                     | PLL1=0, PLL0=1 |                                  |      | 100                               | % of |
| f <sub>STRB</sub>   | Frequency  | To-Top                                   |                |                                  | 50   | f <sub>CKREF</sub>                |      |
|                     |  |  | PLL1=1, PLL0=1 |                                  |      | 33 <sup>1</sup> / <sub>3</sub>    |      |
| t <sub>CPWH</sub>   | CKREF DC   | T=1/f <sub>CKREF</sub>                   |                | 0.2                              | 0.5  | 0.8                               | Т    |
| t <sub>CPWL</sub>   | CKREF DC   | T=1/f <sub>CKREF</sub>                   | ð:             | 0.2                              | 0.5  | 0.8                               | Т    |
| t <sub>CLKT</sub>   | LVCMOS Input<br>Transition Time <sup>(8)</sup>               | 10-90%                                   | 3 3 7          | W.C.                             |      | 20                                | ns   |
| t <sub>SPWH/L</sub> | STROBE Pulse Width<br>HIGH/LOW                               | T=1/f <sub>CKREF</sub>                   | J.Co           | T x <sup>4</sup> / <sub>14</sub> |      | T x <sup>10</sup> / <sub>14</sub> | ns   |
| t <sub>STC</sub>    | DP <sub>(n)</sub> Setup to STROBE                            | DIRI=1, f=5i                             | MHz            | 2.5                              |      |                                   | ns   |
| t <sub>HTC</sub>    | DP <sub>(n)</sub> Hold to STROBE                             | See Figure                               | 7              | 2.0                              |      |                                   | ns   |
| Serializer          | AC Electrical Characteristi                                  | cs                                       |                |                                  |      |                                   |      |
| t <sub>TCCD</sub>   | Transmitter Clock Input to Clock Output Delay <sup>(9)</sup> | DIRI=1, f <sub>CKR</sub><br>See Figure 9 |                | 21a+1.5                          |      | 23a+6.5                           | ns   |
| Phase Loc           | ck Loop (PLL) AC Electrica                                   | l Characteris                            | tics           |                                  |      |                                   |      |
| t <sub>TPLLS0</sub> | Serializer PLL<br>Stabilization Time                         | CKREF toggling and stable                |                | 200                              |      | 600                               | μs   |
| t <sub>TPLLD0</sub> | PLL Disable Time Loss of Clock                               |  |                |                                  |      | 30.0                              | μs   |
| t <sub>TPLLD1</sub> | PLL Power-Down Time  |  |                |                                  |      | 20.0                              | ns   |

#### Notes:

- Parameter is characterized, but not production tested.

  The average bit time "a" is a function of the serializer CKREF frequency; a=(1/f)/14.

#### **AC Electrical Characteristics** (Continued)

Values are provided for over-supply and operating temperature ranges, unless otherwise specified.

| Symbol            | Parameter  | Test Co                                  | onditions                |       | Min.   | Тур. | Max.  | Unit |
|-------------------|--|--|--------------------------|-------|--------|------|-------|------|
| Deserialize       | er AC Electrical Charac  |  |                          |       |        |      |       |      |
|                   |  |  | PWS1                     | PWS0  |        |      |       |      |
|                   |  | $f_{\text{STRB}} = f_{\text{CKREF}}$     | 0                        | 0     | 7a-3   |      | 7a+3  |      |
| t <sub>RCOL</sub> | CKP OUT Low Time<br>See Figure 8 <sup>(10)</sup>   | $f_{\text{STRB}} = f_{\text{CKREF}}$     | 0                        | 1     | 7a-3   |      | 7a+3  | ns   |
|                   | , and the second | $f_{\text{STRB}} = .5x f_{\text{CKREF}}$ | 1                        | 0     | 13a-3  |      | 13a+3 |      |
|                   |  | $f_{\text{STRB}} = .5x f_{\text{CKREF}}$ | 1                        | 1     | 17a-3  |      | 17a+3 |      |
| t <sub>PDV</sub>  | Data Valid to CKP<br>HIGH  | (Rising Edge STR<br>See Figure 8         | OBE) <sup>(10)</sup> , C | L=5pF | 8a-3   |      | 8a+3  | ns   |
|                   | Output Bigg/Eall   |  | S1=0,S0                  | =1    |        | 3.0  |       |      |
| t <sub>RFD</sub>  | Output Rise/Fall<br>Time Data (20% to  | C <sub>L</sub> =8pF                      | S1=1,S0                  | =0    | - 4-   | 8.0  |       | ns   |
|                   | 80%)   |  | S1=1,S0                  | =1 40 | 15- /" | 5.0  |       |      |
|                   |  |  | S1=0,S0                  | 9.19  | C.     | 2.0  |       |      |
| t <sub>RFC</sub>  | Output Rise/Fall Time CKP (20% to  | C <sub>L</sub> =8pF                      | <b>S</b> 1=1,S0          | =0.   |        | 7.0  |       | ns   |
|                   | 80%)   |  | S1=1,S0                  | =1    |        | 4.0  |       |      |

#### Notes:

- 10. Skew is measured from the rising or falling edge of CKSO clock to the rising or falling edge of data (DSO). Signals are edge aligned. Both outputs should have identical load conditions for this test to be valid.
- 11. Signals are transmitted from the serializer source synchronously. In some cases, data is transmitted when the clock remains at a high state. Skew should only be measured when data and clock are transitioning at the same time. Total measured input skew is a combination of output skew from the serializer, load variations, and ISI and jitter effects.

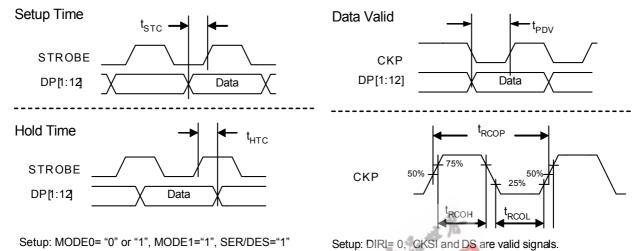
# **Logic Timing Controls**

| Symbol   | Parameter  | Test Conditions              | Min. | Тур. | Max. | Unit |
|--|--|------------------------------|------|------|------|------|
| t <sub>PHL_DIR</sub> ,<br>t <sub>PLH_DIR</sub> | Propagation Delay<br>DIRI to /DIRO                     | DIRI L->H or H->L            |      |      | 17   | ns   |
| t <sub>PLZ</sub> , t <sub>PHZ</sub>            | Propagation Delay<br>DIRI to DP                        | DIRI L->H or H->L            |      |      | 25   | ns   |
| t <sub>DISDES</sub>                            | Deserializer Disable Time: S0 or S1 LOW to DPTri-State | DIRI=0, See Figure 10        |      |      | 25   | ns   |
| t <sub>DISSER</sub>                            | Serializer Disable Time: S0 or S1 LOW to CKP HIGH      | DIRI=1; S1(0) and S0(1)=H->L |      |      | 25   | ns   |

### **Pin Capacitance Tables**

| Symbol               | Parameter                                     | Test Conditions                           | Min. | Тур. | Max. | Unit |
|----------------------|---|---|------|------|------|------|
| C <sub>IN</sub>      | Capacitance of Input Only Signals             | DIRI=1, S1=0, S0=0, V <sub>DD</sub> =2.5V | 3    | 2.0  |      | pF   |
| C <sub>IO</sub>      | Capacitance of Parallel Port<br>Pins DP[1:12] | DIRI=1, S1=0, S0=0, V <sub>DD</sub> =2.5V | n:   | 2.0  |      | pF   |
| C <sub>IO-DIFF</sub> | Capacitance of Differential I/O Signals.      | DIRI=1, S1=0, S0=0, V <sub>DD</sub> =2.5V |      | 2.0  |      | pF   |
|                      |   |   |      |      |      |      |

# **Typical Performance Characteristics**



Setup: MODE0= "0" or "1", MODE1="1", SER/DES="1"

Figure 7. Serializer Setup and Hold Time

**Descrializer Data Valid Time and** 

**Clock Output Parameters** 

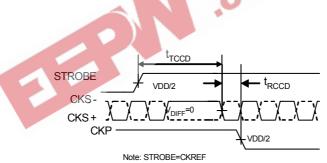
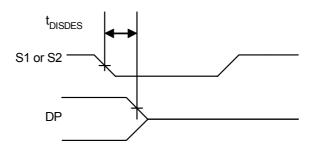


Figure 9. **Clock Propagation Delay** 



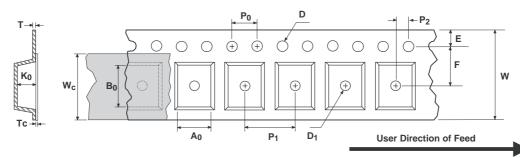
Note: If S1(2) is transitioning, S2(1) must =0 for test to be valid.

Figure 10. Deserializer Disable Timing

#### **Tape and Reel Specifications**

#### **MLP Embossed Tape Dimensions**

Dimensions are in millimeters unless otherwise noted.



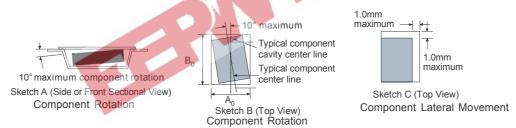
| Package | $A_0$    | $B_0$    | D     | $D_1$      | E    | F    | $K_0$ | $\mathbf{P}_{1}$ | $P_0$  | $P_2$ | T    | T <sub>c</sub> | W    | Wc       |
|---------|----------|----------|-------|------------|------|------|-------|------------------|--------|-------|------|----------------|------|----------|
| 5x5     | 5.35±0.1 | 5.35±0.1 | 1.55  | 1.5 min.   | 1.75 | 5.5  | 1.4   | 8 typ.           | 4 tvp. | 2.0   | 0.3  | 0.07           | 12   | 0 3 tvn  |
| 6x6     | 6.30±0.1 | 6.30±0.1 | ±0.05 | 1.5 11111. | ±0.1 | ±0.1 | ±0.1  | ο ιγρ.           | 4 typ. | 0.05± | typ. | ±0.005         | ±0.3 | 9.3 typ. |

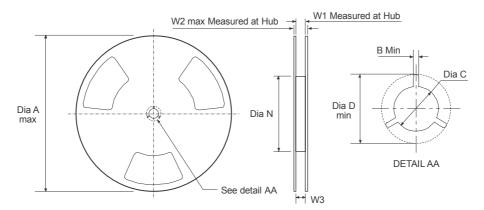
#### Notes:

 $A_0$ ,  $B_0$ , and  $K_0$  dimensions are determined with respect to the EIA/JEDEC RS-481 rotational and lateral movement requirements (see sketches A, B, and C).

#### **MLP Shipping Reel Dimensions**

Dimensions are in millimeters unless otherwise noted.



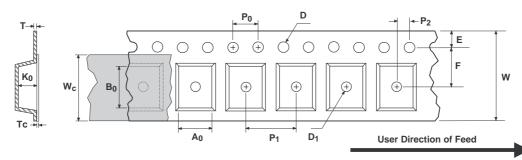


| Tape<br>Width | Dia A      | Dim B    | Dia C             | Dia D     | Dim N      | Dim W1         | Dim W2    | Dim W3<br>(LSL-USL) |
|---------------|------------|----------|-------------------|-----------|------------|----------------|-----------|---------------------|
| 8             |            |          | 40.0              |           |            | •              | 14.4 max. | 7.9 ~ 10.4          |
| 12            | 330.0 max. | 1.5 min. | 13.0<br>+0.5/-0.2 | 20.2 min. | 178.0 min. | 8.4<br>+2.0/-0 | 18.4 max. | 11.9 ~ 15.4         |
| 16            |            |          | +0.5/-0.2         |           |            | 12.07-0        | 22.4 max. | 15.9 ~ 19.4         |

#### **Tape and Reel Specifications** (Continued)

#### **BGA Embossed Tape Dimensions**

Dimensions are in millimeters unless otherwise noted.



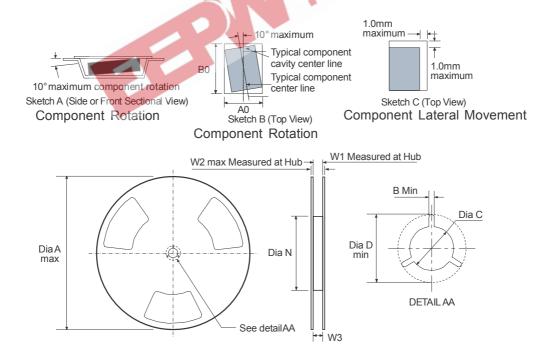
| Package   | $A_0$   | B <sub>0</sub> | D             | D <sub>1</sub> | E            | F           | K <sub>0</sub> | P <sub>1</sub> | Po          | P <sub>2</sub> | T           | T <sub>c</sub> | W          | Wc          |
|-----------|---------|----------------|---------------|----------------|--------------|-------------|----------------|----------------|-------------|----------------|-------------|----------------|------------|-------------|
| 3.5 x 4.5 | TBD±0.1 | TBD±0.1        | 1.55<br>±0.05 | 1.5<br>min.    | 1.75<br>±0.1 | 5.5<br>±0.1 | 1.1<br>±0.1    | 8.0<br>typ.    | 4.0<br>typ. | 2.0<br>±0/05   | 0.3<br>typ. | 0.07<br>±0.005 | 12<br>±0.3 | 9.3<br>typ. |

#### Notes:

 $A_0$ ,  $B_0$ , and  $K_0$  dimensions are determined with respect to the EIA/JEDEC RS-481 rotational and lateral movement requirements (see sketches A, B, and C).

#### **BGA Shipping Reel Dimensions**

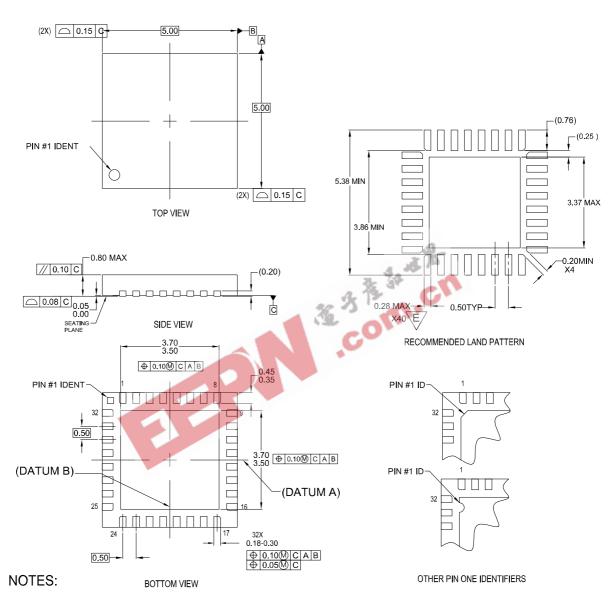
Dimensions are in millimeters unless otherwise noted



| Tape<br>Width | Dia A      | Dim B    | Dia C             | Dia D     | Dim N      | Dim W1         | Dim W2    | Dim W3<br>(LSL-USL) |
|---------------|------------|----------|-------------------|-----------|------------|----------------|-----------|---------------------|
| 8             |            |          | 40.0              |           |            | •              | 14.4 max. | 7.9 ~ 10.4          |
| 12            | 330.0 max. | 1.5 min. | 13.0<br>+0.5/-0.2 | 20.2 min. | 178.0 min. | 8.4<br>+2.0/-0 | 18.4 max. | 11.9 ~ 15.4         |
| 16            |            |          | +0.5/-0.2         |           |            | 12.07-0        | 22.4 max. | 15.9 ~ 19.4         |

#### **Physical Dimensions**

Dimensions are in millimeters unless otherwise noted.



- A. CONFORMS TO JEDEC REGISTRATION MO-220, VARIATION WHHD-4 THIS PACKAGE IS ALSO FOOTPRINT COMPATIBLE WITH WHHD-5
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994
- D. LAND PATTERN PER IPC SM-782 FABRICATION AND ASSEMBLY TOLERANCES OF 0.1 MM APPLIED
- E. WIDTH REDUCED TO AVOID SOLDER BRIDGING.
- G. DIMENSIONS ARE NOT INCLUSIVE OF BURRS, MOLD FLASH, NOR TIE BAR PROTRUSIONS.

#### MLP032ArevB

Figure 11. 32-Lead, Molded Leadless Package (MLP)

#### Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.

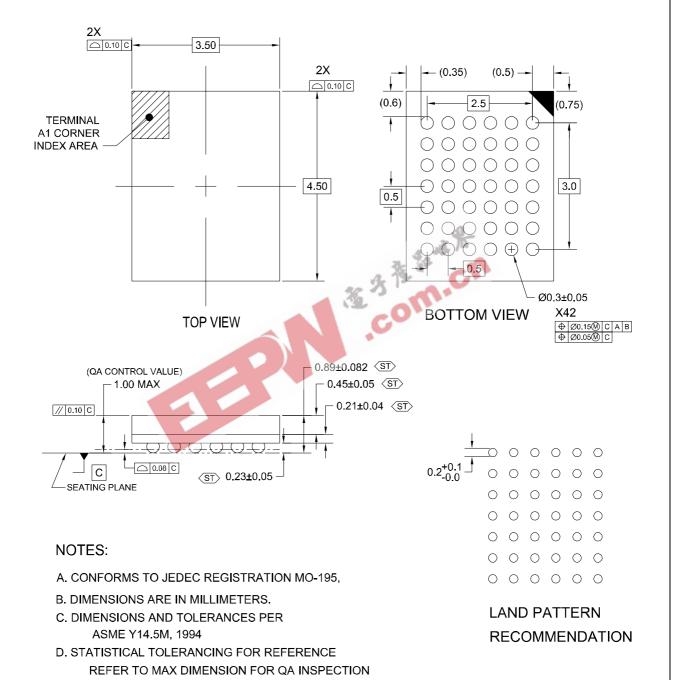


Figure 12. 42-Ball, Ball Grid Array (BGA) Package

E. LAND PATTERN RECOMENDATION PER IPC-7351 TABLE14-15

LAND PATTERN NAME PER TABLE 3-15: BGA50P+6X7-42

BGA42ArevB





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